## $\square$ MN101C49 Series

| Type | MN101C49G | MN101C49H | MN101C49K | MN101CF49K | MN101CP49K |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Internal ROM type | Mask ROM |  |  | FLASH | EPROM |
| ROM (byte) | 128K | 160K | 224 K |  |  |
| RAM (byte) | 4K | 6K | 10K |  |  |
| Package (Lead-free) | LQFP100-P-1414, QFP100-P-1818B |  |  |  |  |
| Minimum Instruction Execution Time |  |  |  |  |  |

## ■ Interrupts

RESET. Watchdog. External 0 to 5. Timer 0 to 4. Timer 6. Timer 7 (2 systems). Time base. Serial 0 to 3. Automatic transfer finish. A/D conversion finish. Key interrupts (8 lines)

## - Timer Counter

8 -bit timer $\times 6$
Timer 0 .................Square-wave/8-bit PWM output. Event count. Remote control carrier output. Pulse width measurement
Timer 1 ..................Square-wave output. Event count. Synchronous output event
Timer 2 ..................Square-wave/8-bit PWM output. Event count. Synchronous output event. Pulse width measurement
Timer 3 ..................Square-wave output. Event count. Remote control carrier output
Timer $4 \ldots \ldots . . . . . . . . .$. Square-wave/8-bit PWM output. Event count. Pulse width measurement. Serial 1 baud rate timer
Timer 6 .................. 8 -bit freerun timer
Timer 0,1 can be cascade-connected
Timer 2, 3 can be cascade-connected
16-bit timer $\times 1$
Timer 7 ..................Square-wave/16-bit PWM output (cycle/duty continuous variable). Event count. Synchronous output event. Pulse width measurement. Input capture
Time base timer: One-minute count setting
Watchdog timer $\times 1$

## $\square$ Serial interface

Synchronous type/UART (full-duplex) $\times 1$ : Serial 0
Synchronous type/Simple UART (half-duplex) $\times 1$ : Serial 1
Synchronous type $\times 1$ : Serial 2
Synchronous type/Single-master $\mathrm{I}^{2} \mathrm{C} \times 1$ : Serial 3

- DMA controller

Maximum transfer cycles: 255
Starting factor: External request. Various types of interrupt. Software
Transfer mode: 1-byte transfer. Word transfer. Burst transfer

- I/O Pins

I/O 73 : Common use. Specified pull-up resistor available. Input/output selectable (bit unit)
(72) : Flash memory built-in type

Input $\quad 15$ : Common use. Specified pull-up resistor available
(14) : Flash memory built-in type

A/D converter
10 -bit $\times 8$ channels (with $\mathrm{S} / \mathrm{H}$ )

- D/A converter

8 -bit $\times 4$ channels
Special Ports
Buzzer output. Remote control carrier output. High-current drive port

- ROM Correction

Correcting address designation: Up to 3 addresses possible
■ Electrical Charactreistics (Supply current)

| Parameter | Symbol | Condition | Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Operating supply current | IDD1 | fosc $=20 \mathrm{MHz} . \mathrm{VDD}=5 \mathrm{~V}$ |  | 30 | 70 | mA |
|  | IDD2 | fosc $=8.39 \mathrm{MHz} . \mathrm{VDD}=5 \mathrm{~V}$ |  | 15 | 30 | mA |
|  | IDD3 | $\mathrm{fx}=32.768 \mathrm{kHz} . \mathrm{VDD}=3 \mathrm{~V}$ |  | 40 | 120 | $\mu \mathrm{A}$ |
| Supply current at HALT | IDD4 | $\mathrm{fx}=32 \mathrm{kHz} . \mathrm{VDD}=3 \mathrm{~V}(5 \mathrm{~V}) . \mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 5(13) | 11(30) | $\mu \mathrm{A}$ |
|  | IDD5 | $\mathrm{fx}=32.768 \mathrm{kHz} . \mathrm{VDD}=3 \mathrm{~V}(5 \mathrm{~V}) . \mathrm{Ta}=85^{\circ} \mathrm{C}$ |  |  | 30(90) | $\mu \mathrm{A}$ |
| Supply current at STOP | IDD6 | $\mathrm{VDD}=5 \mathrm{~V} . \mathrm{Ta}=25^{\circ} \mathrm{C}$ |  |  | 3 | $\mu \mathrm{A}$ |
|  | IDD7 | $\mathrm{VDD}=5 \mathrm{~V} . \mathrm{Ta}=85^{\circ} \mathrm{C}$ |  |  | 60 | $\mu \mathrm{A}$ |

Note) ( ): Flash memory built-in type
$\square$ Pin Assignment
QFP100-P-1818B, LQFP100-P-1414


Note) (): Flash memory built-in type

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